Unbuffered inverter Rev. 1 — 14 May 2013

Product data sheet

1. General description

The 74LVC1GU04-Q100 is a single unbuffered inverter.

The input can be driven from either 3.3 V or 5 V devices. This feature allows the use of this device in a mixed 3.3 V and 5 V environment.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 1.65 V to 5.5 V
- High noise immunity
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pf, R = 0 Ω)
- ± 24 mA output drive (V_{CC} = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Input accepts voltages up to 5 V

3. Ordering information

Table 1.Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC1GU04GW-Q100	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1
74LVC1GU04GV-Q100	–40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753

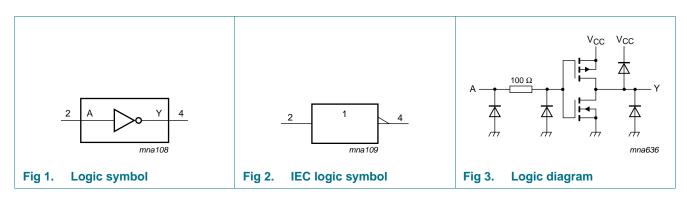


4. Marking

Table 2. Marking codes	
Type number	Marking ^[1]
74LVC1GU04GW-Q100	VD
74LVC1GU04GV-Q100	VU4

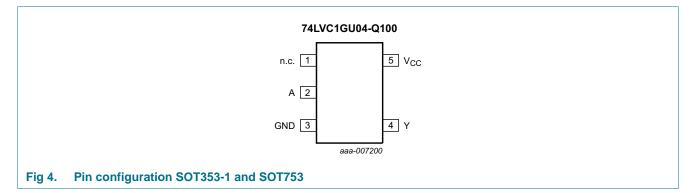
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
n.c.	1	not connected
А	2	data input
GND	3	ground (0 V)
Y	4	data output
V _{CC}	5	supply voltage

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7. Functional description

Table 4.	Function table ^[1]
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Input (A)	Output (Y)
L	Н
Н	L

[1] H = HIGH voltage level; L = LOW voltage level.

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-	-50	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
Ι _{ΟΚ}	output clamping current	$V_{O} > V_{CC}$ or $V_{O} < 0 V$	-	±50	mA
Vo	output voltage	Active mode	<u>[1][2]</u> –0.5	V _{CC} + 0.5	V
Ι _Ο	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	+100	mA
I _{GND}	ground current		-	-100	mA
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[3]	250	mW
T _{stg}	storage temperature		-65	+150	°C
-					

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] When $V_{CC} = 0 V$ (Power-down mode), the output voltage can be 5.5 V in normal operation.

[3] For TSSOP5 and SC-74A packages: above 87.5 °C the value of Ptot derates linearly with 4.0 mW/K.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V _{CC}	supply voltage		1.65	-	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	Active mode	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
		$V_{CC} = 2.7 \text{ V} \text{ to } 5.5 \text{ V}$	0	-	10	ns/V

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10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
T _{amb} = -	40 °C to +85 °C					
VIH	HIGH-level input voltage	V_{CC} = 1.65 V to 5.5 V	$0.75\times V_{CC}$	-	-	V
VIL	LOW-level input voltage	V_{CC} = 1.65 V to 5.5 V	-	-	$0.25\times V_{CC}$	V
V _{OH}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		I _O = -100 μA; V _{CC} = 1.65 V to 5.5 V	$V_{CC}-0.1$	-	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	V
		I_{O} = -8 mA; V_{CC} = 2.3 V	1.9	-	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.3	-	-	V
		$I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.8	-	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		I _O = 100 μA; V _{CC} = 1.65 V to 5.5 V	-	-	0.1	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.3	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	V
		$I_{O} = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.55	V
I	input leakage current	$V_{\rm I}$ = 5.5 V or GND; $V_{\rm CC}$ = 0 V to 5.5 V	-	±0.1	±5	μA
lcc	supply current	$V_{I} = 5.5 V \text{ or GND}; I_{O} = 0 A;$ $V_{CC} = 1.65 V \text{ to } 5.5 V$	-	0.1	10	μA
Cı	input capacitance	V_{CC} = 3.3 V; V_{I} = GND to V_{CC}	-	6	-	pF
T _{amb} = -	40 °C to +125 °C					
VIH	HIGH-level input voltage	V_{CC} = 1.65 V to 5.5 V	$0.8\times V_{CC}$	-	-	V
VIL	LOW-level input voltage	V_{CC} = 1.65 V to 5.5 V	-	-	$0.2\times V_{CC}$	V
V _{он}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		I _O = −100 μA; V _{CC} = 1.65 V to 5.5 V	$V_{CC}-0.1$	-	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	0.95	-	-	V
		I_O = -8 mA; V_{CC} = 2.3 V	1.7	-	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	1.9	-	-	V
		$I_0 = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.0	-	-	V
		$I_0 = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.4	-	-	V

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Table 7. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH}$ or V_{IL}				
	I _O = 100 μA; V _{CC} = 1.65 V to 5.5 V	-	-	0.1	V	
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.7	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.45	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.6	V
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.80	V
		$I_0 = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.80	V
I _I	input leakage current	$V_{\rm I}$ = 5.5 V or GND; $V_{\rm CC}$ = 0 V to 5.5 V	-	±0.1	±5	μΑ
I _{CC}	supply current	$V_{I} = 5.5 V \text{ or GND}; I_{O} = 0 \text{ A};$ $V_{CC} = 1.65 V \text{ to } 5.5 V$	-	-	200	μΑ

[1] All typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit, see Figure 8.

Symbol	Parameter	Conditions	–40 °C to +85 °C			S°C	-40 °C to	Unit	
				Min	Typ <mark>[1]</mark>	Мах	Min	Max	
t _{pd}	propagation delay	A to Y; see Figure 5	[2]						
		V_{CC} = 1.65 V to 1.95 V		0.3	1.7	5.0	0.3	6.5	ns
		V_{CC} = 2.3 V to 2.7 V		0.3	1.3	4.0	0.3	5.5	ns
		$V_{CC} = 2.7 V$		0.5	1.7	5.0	0.5	6.5	ns
		V_{CC} = 3.0 V to 3.6 V		0.5	1.6	3.7	0.5	5.0	ns
		V_{CC} = 4.5 V to 5.5 V		0.5	1.3	3.0	0.5	4.0	ns
C _{PD}	power dissipation capacitance	$V_I = GND$ to V_{CC} ; $V_{CC} = 3.3 V$	[3]	-	14.9	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).
 - $\mathsf{P}_{\mathsf{D}} = \mathsf{C}_{\mathsf{P}\mathsf{D}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}^2 \times \mathsf{f}_i \times \mathsf{N} + \sum (\mathsf{C}_{\mathsf{L}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}^2 \times \mathsf{f}_o) \text{ where:}$

 f_i = input frequency in MHz;

 f_o = output frequency in MHz;

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs.

^[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

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12. Waveforms

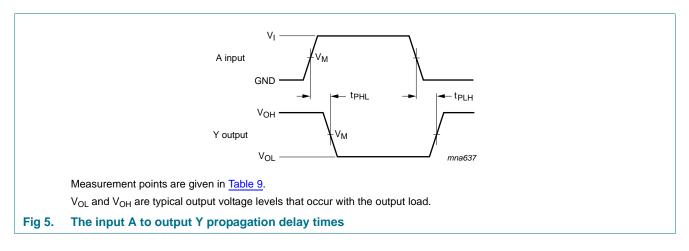
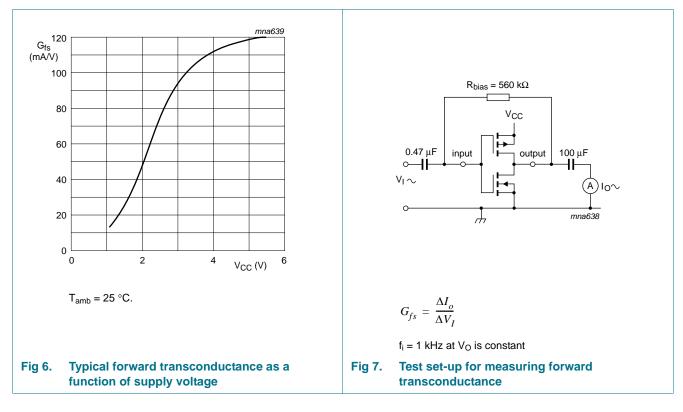


Table 9. Measurement points

Supply voltage	Input	Output	
V _{cc}	V _M	V _M	
1.65 V to 1.95 V	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$	
2.3 V to 2.7 V	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$	
2.7 V	1.5 V	1.5 V	
3.0 V to 3.6 V	1.5 V	1.5 V	
4.5 V to 5.5 V	$0.5\times V_{CC}$	$0.5 imes V_{CC}$	



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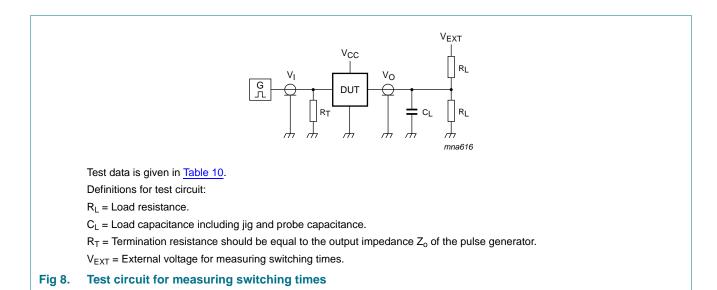


Table 10. Test data

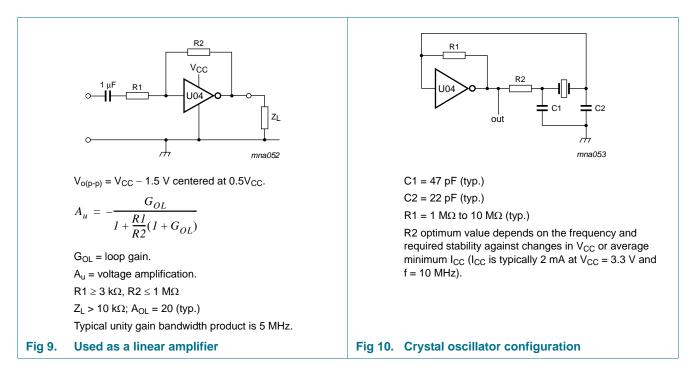
Supply voltage	Input		Load		V _{EXT}
V _{cc}	VI	$t_r = t_f$	CL	RL	t _{PLH} , t _{PHL}
1.65 V to 1.95 V	V _{CC}	\leq 2.0 ns	30 pF	1 kΩ	open
2.3 V to 2.7 V	V _{CC}	\leq 2.0 ns	30 pF	500 Ω	open
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open
4.5 V to 5.5 V	V _{CC}	\leq 2.5 ns	50 pF	500 Ω	open

13. Application information

Some applications are:

- Linear amplifier (see Figure 9)
- In crystal oscillator design (see Figure 10)

Remark: All values given are typical unless otherwise specified.



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14. Package outline

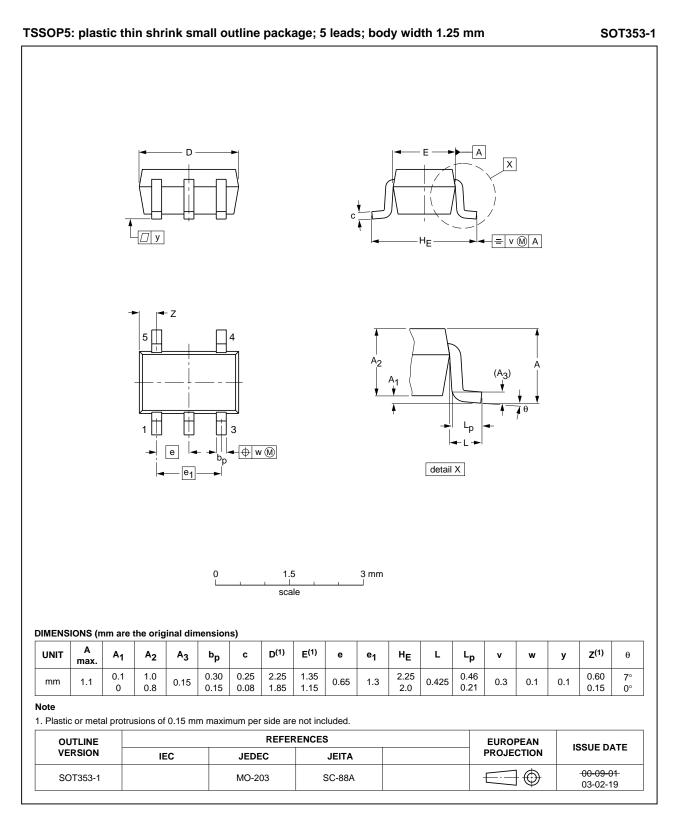


Fig 11. Package outline SOT353-1 (TSSOP5)

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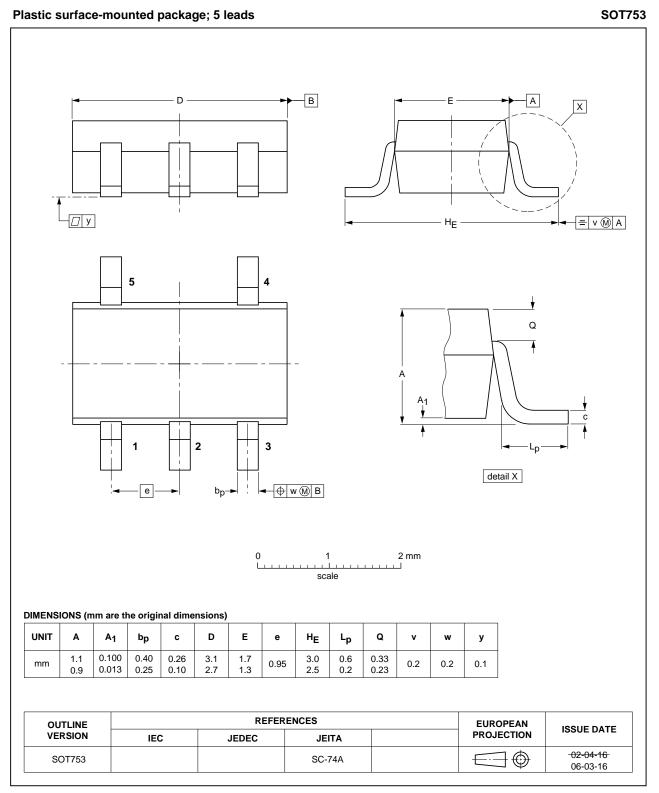


Fig 12. Package outline SOT753 (SC-74A)

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15. Abbreviations

Table 11. Abbreviations				
Acronym	Description			
CMOS	Complementary Metal Oxide Semiconductor			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			
MIL	Military			

16. Revision history

Table 12. Revision history							
Document ID	Release date	Data sheet status	Change notice	Supersedes			
74LVC1GU04_Q100 v.1	20130514	Product data sheet	-	-			

17. Legal information

17.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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